half-bridge

Example Bill of Materials for Half Bridge

You need to verify component values are compatible with your application!

| C1 | 2.2 uF MKP (polyproplyene) DC Link capacitor (e.g. TDK B32673P6225K) |
|------|--|
| C2 | 2.2 uF MKP (polyproplyene) DC Link capacitor (e.g. TDK B32673P6225K) |
| | Installing both C1 and C2 is highly recommended! |
| D1 | 1N5819 |
| D2 | 1N5819 |
| D3 | 1N5819 |
| D4 | 1N5819 |
| D5 | 1N5819 |
| D6 | 1N5819 |
| D7 | 1N5819 |
| D8 | 1N5819 |
| J7 | 2 position 5.0/5.04 mm spacing screw terminal block PCB mount |
| Ј8 | 2 position 5.0/5.04 mm spacing screw terminal block PCB mount |
| Q1 | TO-247 IGBT of your choice e.g. FGY75N60SMD Heatsink is required! |
| Q2 | TO-247 IGBT of your choice e.g. FGY75N60SMD Heatsink is required! |
| Q3 | TO-247 IGBT of your choice e.g. FGY75N60SMD Heatsink is required! |
| Q4 | TO-247 IGBT of your choice e.g. FGY75N60SMD Heatsink is required! |
| Q5 | TO-247 IGBT of your choice e.g. FGY75N60SMD Heatsink is required! |
| Q6 | TO-247 IGBT of your choice e.g. FGY75N60SMD Heatsink is required! |
| Q7 | TO-247 IGBT of your choice e.g. FGY75N60SMD Heatsink is required! |
| Q8 | TO-247 IGBT of your choice e.g. FGY75N60SMD Heatsink is required! |
| R1 | 5R to 10R $\frac{1}{2}$ watt metal film gate resistor |
| R2 | 5R to 10R $\frac{1}{2}$ watt metal film gate resistor |
| R3 | 5R to 10R $\frac{1}{2}$ watt metal film gate resistor |
| R4 | 5R to 10R $\frac{1}{2}$ watt metal film gate resistor |
| R5 | 5R to 10R $\frac{1}{2}$ watt metal film gate resistor |
| R6 | 5R to 10R $\frac{1}{2}$ watt metal film gate resistor |
| R7 | 5R to 10R $\frac{1}{2}$ watt metal film gate resistor |
| R8 | 5R to 10R $\frac{1}{2}$ watt metal film gate resistor |
| | Gate resistors on all IGBTs must be the same resistance! |
| TVS1 | Vishay 1.5KE30CA-E3/51 |
| TVS2 | Vishay 1.5KE30CA-E3/51 |
| TVS3 | Littelfuse 1.5KE400C-B 400 V bidirectional TVS |
| TVS4 | Littelfuse 1.5KE400C-B 400 V bidirectional TVS |